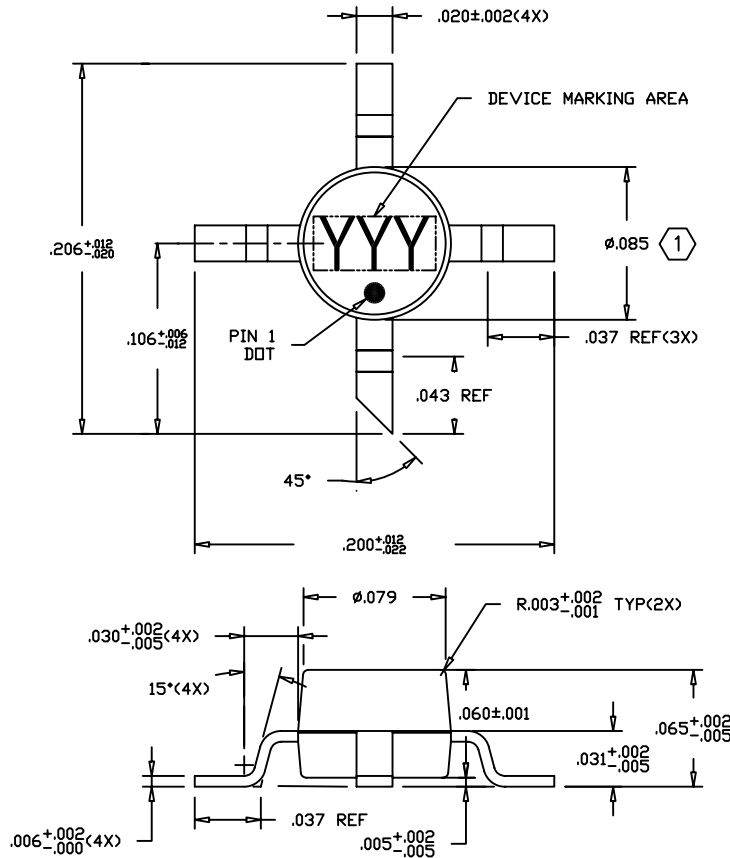


**PROPRIETARY DATA**

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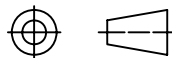
REVISION HISTORY				
REV	DESCRIPTION	ECD	APPR	DATE
A	INITIAL RELEASE	1024	BARCOME	3/12/01
B	REVISED LEAD LENGTH	1396	Barcome	10/31/01
C	LAND PATTERN AND SOLDER MASK		BARCOME	
D	ADD NOTES DIMENSIONS	7958	SCHEEL	9/25/07



**NOTES:**

- THIS DIMENSION DOES NOT INCLUDE MOLD FLASHING PROTRUSIONS AND MOLD TOP AND BOTTOM MISALIGNMENT.
- DUMBAR PROTRUSIONS AND BURRS SHALL NOT EXCEED .002 PER SURFACE.
- MOLDED PACKAGE MISALIGNMENT WITH REFERENCE TO CENTERLINE OF THE LEADFRAME SHALL NOT EXCEED .003. MISALIGNMENT BETWEEN THE UPPER LOWER PACKAGE SHALL NOT EXCEED .003.
- LEADS TO BE COPLANAR WITHIN .003.
- LEAD FOOT TOE AND HEEL SHALL BE WITHIN .003 OF THE HORIZONTAL PLANE.

THIRD ANGLE PROJECTION



UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN INCHES PER ANSI Y14.5M-1982.

TOLERANCES ARE:  
DECIMAL .XX ±.01  
.XXX ±.003

MATERIAL(S):  
FINISH:  
WHERE USED:

DO NOT SCALE DRAWING

SIGNATURE DATE

DRW

CKD

APD

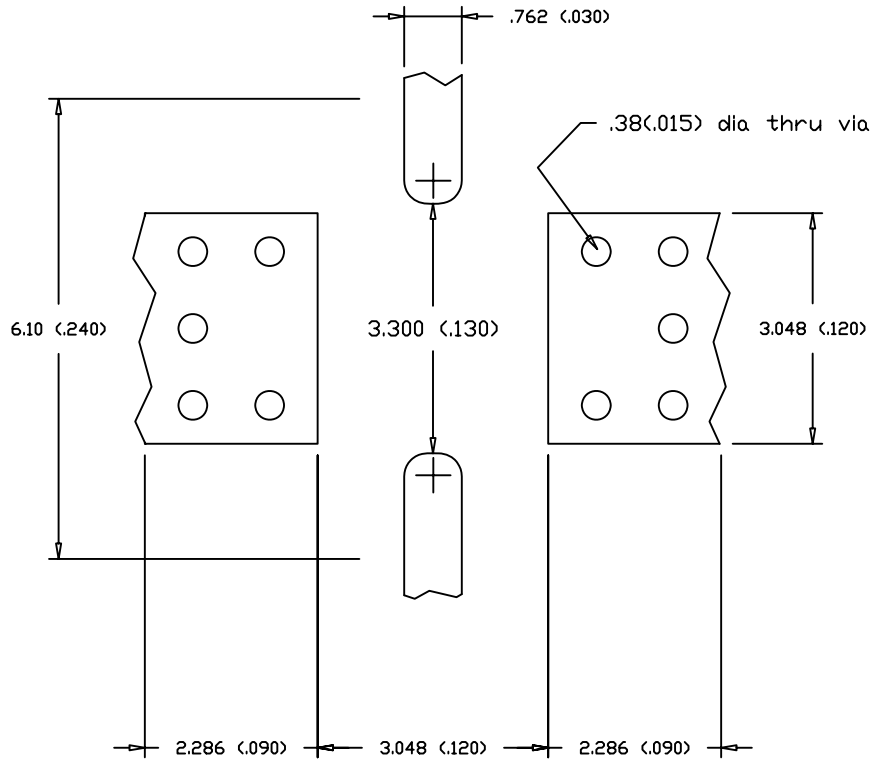
DWG PATH/FILENAME:



DWG TITLE: 86 PLASTIC PACKAGE  
OUTLINE SPECIFICATION

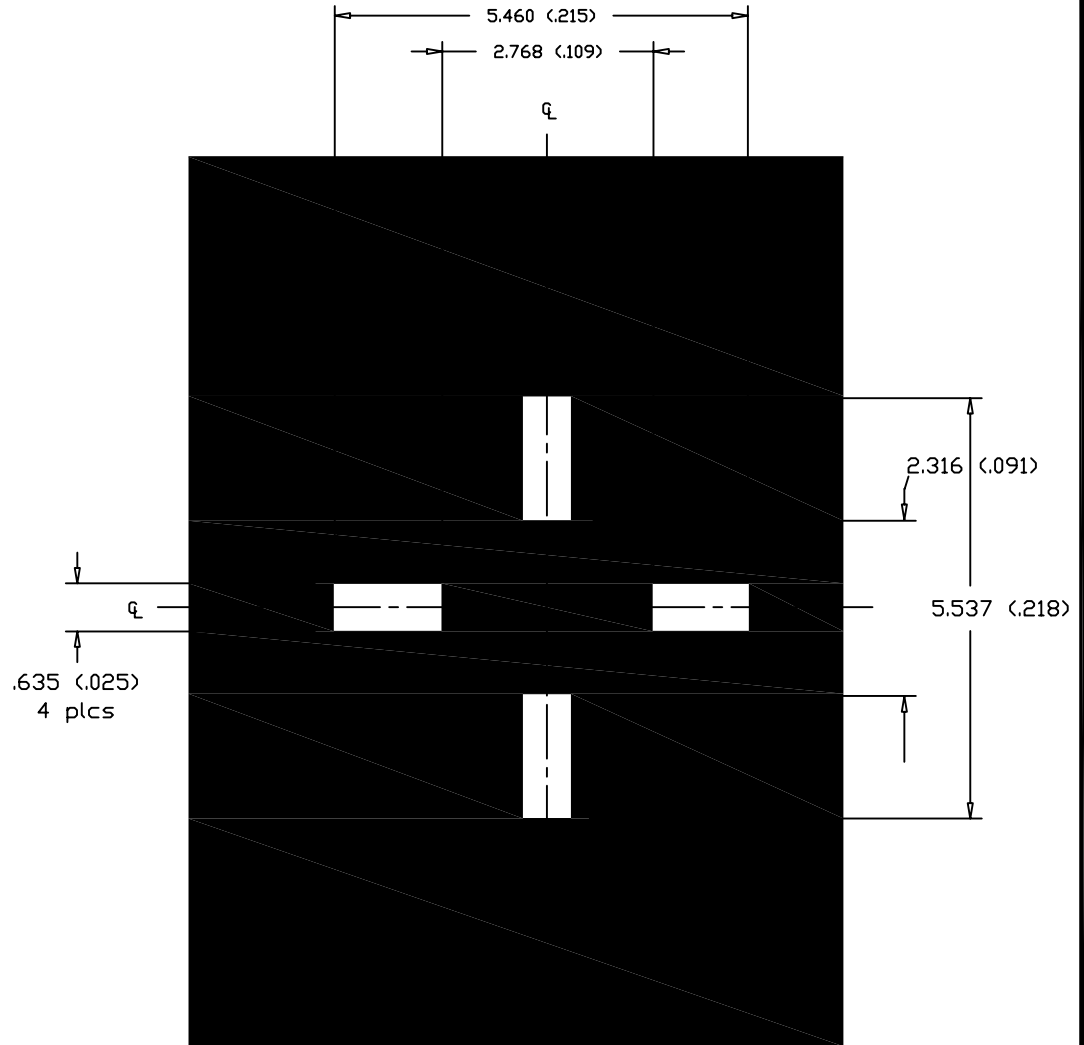
SIZE B	DWG NO. MPQ-100133	REV D
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Caution: The Land Patterns and Solder Mask shown are generic for this package.  
 Refer to product data sheet for any required variations specific to an application.



Scale 10:1

- Generic Land Pattern -



Scale 10:1

- Generic Solder Mask Opening -

- Do Not Scale Hard Copy -



Package Type:

SOT-86 (Micro X) 4 Id

SMDI Package Type: XXX-XX86

Dwg No.

MPO-100133

Sht

2 of 2

REV

D